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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFINA CAZOCALA
09/864,208	05/25/2001	Norio Kimura	2001_0660A	CONFIRMATION NO.
	590 11/37/2004	EXAMINER		
WENDEROTH, LIND & PONACK, L.L.P. 2033 K STREET N. W. SUITE 800 WASHINGTON, DC 20006-1021			LUND, JEFFRIE ROBERT	
			ART UNIT	PAPER NUMBER
20000 1021			1763	
			DATE MAILED: 11/17/2004	

Please find below and/or attached an Office communication concerning this application or proceeding.

	Application No.	Applicant(s)
Office Action Summer.	09/864,208	KIMURA ET AL.
Office Action Summary	Examiner	Art Unit
The MAN INC. DATE:	Jeffrie R. Lund	1763
The MAILING DATE of this communication app Period for Reply	ears on the cover sheet w	th the correspondence address
3) Since this application is in condition for allowan	within the statutory minimum of thirt ill apply and will expire SIX (6) MON cause the application to become AB date of this communication, even if the experiment of the exper	eply be timely filed y (30) days will be considered timely. THS from the mailing date of this communication. ANDONED (35 U.S.C. § 133). Imply filed, may reduce any
closed in accordance with the practice under Ex	c parte Quayle, 1935 C.D.	11. 453 O G 213
Disposition of Claims	, , , , , , , , , , , , , , , , , , ,	,
 4)	rawn from consideration.	1.
Application Papers		
 9) The specification is objected to by the Examiner. 10) The drawing(s) filed on <u>08 January 2004</u> is/are: Applicant may not request that any objection to the dr. Replacement drawing sheet(s) including the correction 11) The oath or declaration is objected to by the Exam 	awing(s) be held in abeyance is required if the drawing(s)	e. See 37 CFR 1.85(a).
Priority under 35 U.S.C. § 119		· · · · · · · · · · · · · · · · · · ·
12) Acknowledgment is made of a claim for foreign pr a) All b) Some * c) None of: 1. Certified copies of the priority documents h 2. Certified copies of the priority documents h 3. Copies of the certified copies of the priority application from the International Bureau (F * See the attached detailed Office action for a list of the second company of the certified copies of the priority application from the International Bureau (F)	ave been received. ave been received in App documents have been re	lication No ceived in this National Stage
tachment(s)		
Notice of References Cited (PTO-892) Notice of Draftsperson's Patent Drawing Review (PTO-948) Information Disclosure Statement(s) (PTO-1449 or PTO/SB/08) Paper No(s)/Mail Date	4) Interview Sumi Paper No(s)/M 5) Notice of Inforr 6) Other:	mary (PTO-413) ail Date nal Patent Application (PTO-152)

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DETAILED ACTION

Claim Rejections - 35 USC § 103

- 1. The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:
 - (a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.
- 2. Claims 16 and 23 are rejected under 35 U.S.C. 103(a) as being unpatentable over Laursen et al, US Patent 6,071,816, in view of Lehman et al, US Patent 6,621,264 B1.

Laursen et al teaches a method of chemical mechanical planarization (polishing) of a first metal layer 2 and a second metal layer 4 that includes the steps of: polishing the first metal layer by pressing and moving the first metal layer against a polishing surface with a first polishing fluid; detecting the end point; rinsing (cleaning) the polishing surface using water; polishing the second metal layer by pressing and moving the second metal layer against the polishing surface with a second polishing fluid; and measuring the second metal layer until it reaches a second end point. (Entire document, specifically, column 3 line 65 through column 4 line 17)

Laursen et al differs from the present invention in that Laursen et al does not teach that an eddy current monitor detects the stop point of the first polishing step and an optical film thickness monitor measures the thickness of the second metal layer during the second polishing step.

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Lehman et al teaches that an eddy current monitor works well with thick films (i.e. the first film) and the optical film thickness monitor works better with thin films (column 13 lines 7-43), and that the thickness measurement can be stored for future reference.

The motivation for measuring the first end point with an eddy current monitor and the second end point with an optical film thickness monitor is to use the most accurate measurement system as taught by Lehman et al in measuring the end points as required by Laursen et al but only generically described.

Therefore it would have been obvious to one of ordinary skill in the art at the time the invention was made to measure the end points of Laursen et al with the eddy current monitor and optical film thickness monitor of Lehman et al.

3. Claims 18, 20, 25, and 27 are rejected under 35 U.S.C. 103(a) as being unpatentable over Laursen et al and Lehman et al as applied to claims 16 and 23 above, and further in view of Hara et al, 6,451,696 B1.

Laursen et al and Lehman et al differ from the present invention in that they do not teach that the second metal layer of the substrate is pressed against the polishing surface by a load which is smaller than the load when polishing the first metal layer, the first and second polishing liquids have a PH at the same side of PH 7.

Hara et al teaches a polishing method that includes a first etching step having a load of 200 gf/cm² and a PH of 10.5, and a second etching step having a load of 100 gf/cm² and a PH of 10.5. (Column 12 lines 14-37)

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The motivation for reducing the load and maintaining the PH of the slurry on the same side of PH 7 is to optimize the speed and quality of the polishing process as taught by Hara et al.

Therefore it would have been obvious to one of ordinary skill in the art at the time the invention was made to optimize the load and maintain the PH of the slurry in the method of Laursen et al and Lehman et al as taught by Hara et al.

4. Claims 18, 20, 25, and 27 are rejected under 35 U.S.C. 103(a) as being unpatentable over Laursen et al and Lehman et al as applied to claims 16 and 23 above, and further in view of Allen et al, 6,292,708 B1.

Laursen et al and Lehman et al differ from the present invention in that they do not teach cleaning and drying the substrate after the second polishing step is complete.

Allen et al teaches cleaning and drying a substrate after the substrate is polished. The motivation for reducing the load and maintaining the PH of the slurry on the same side of PH 7 is to optimize the speed and quality of the polishing process as taught by Allen et al.

The motivation for cleaning and drying the substrates is to clean and dry the substrates after they have been polished as taught by Allen et al.

Therefore it would have been obvious to one of ordinary skill in the art at the time the invention was made to clean and dry the substrates of Laursen et al and Lehman et al as taught by Allen et al.

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Response to Arguments

5. Applicant's arguments with respect to claims 16 and 23 have been considered but are most in view of the new ground(s) of rejection.

Conclusion

6. The prior art made of record and not relied upon is considered pertinent to applicant's disclosure. The cited art teaches the technological background of the invention.

Any inquiry concerning this communication or earlier communications from the examiner should be directed to Jeffrie R. Lund whose telephone number is (571) 272-1437. The examiner can normally be reached on Monday-Thursday (6:30 am-6:00pm).

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Gregory Mills can be reached on (571) 272-1439. The fax phone number for the organization where this application or proceeding is assigned is 703-872-9306.

Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see http://pair-direct.uspto.gov. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free).

Jeffrie R. Lund Primary Examiner Art Unit 1763